SGM8631 SGM8632 SGM8633 SGM8634

470µA, 6MHz, Rail-to-Rail I/O CMOS Operational Amplifier

PRODUCT DESCRIPTION

The SGM8631(single), SGM8632(dual), SGM8633(single with shutdown) and SGM8634 (quad) are low noise, low voltage, and low power operational amplifiers, that can be designed into a wide range of applications. The SGM8631/2/3/4 have a high gain-bandwidth product of 6MHz, a slew rate of $3.7V/\mu s$, and a quiescent current of $470\mu A/amplifier$ at 5V. The SGM8633 has a power-down disable feature that reduces the supply current to 90nA.

The SGM8631/2/3/4 are designed to provide optimal performance in low voltage and low noise systems. They provide rail-to-rail output swing into heavy loads. The input common-mode voltage range includes ground, and the maximum input offset voltage are 3.5mV for SGM8631/2/3/4. They are specified over the extended industrial temperature range (-40°C to +125°C). The operating range is from 2.5V to 5.5V.

The single version, SGM8631/8633, is available in SC70-5, SO-8 and SOT23-5(6) packages. The dual version SGM8632 is available in SO-8 and MSOP-8 packages. The quad version SGM8634 is available in SO-16 and TSSOP-16 packages.

APPLICATIONS

Sensors
Audio
Active Filters
A/D Converters
Communications
Test Equipment
Cellular and Cordless Phones
Laptops and PDAs
Photodiode Amplification
Battery-Powered Instrumentation

FEATURES

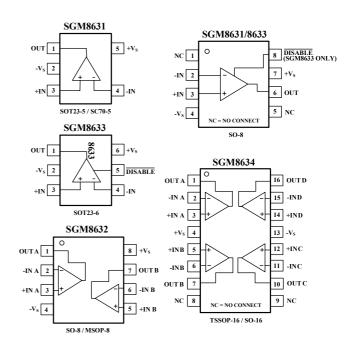
- Low Cost
- Rail-to-Rail Input and Output 0.8mV Typical Vos
- High Gain-Bandwidth Product: 6MHz
- High Slew Rate: 3.7V/µs
- Settling Time to 0.1% with 2V Step: 2.1µs
- Overload Recovery Time: 0.9µs
- Low Noise : 12 nV/ \sqrt{Hz}
- Operates on 2.5 V to 5.5V Supplies
- Input Voltage Range = -0.1 V to +5.6 V with $\text{V}_{\text{S}} = 5.5 \text{ V}$
- Low Power

470μA/Amplifier Typical Supply Current SGM8633 90nA when Disabled

• Small Packaging

SGM8631 Available in SC70-5, SOT23-5 and SO-8 SGM8632 Available in MSOP-8 and SO-8 SGM8633 Available in SOT23-6 and SO-8 SGM8634 Available in TSSOP-16 and SO-16

PIN CONFIGURATIONS (Top View)



ELECTRICAL CHARACTERISTICS : Vs = +5V

(At $T_A = +25$ °C, $V_{CM} = V_S/2$, $R_L = 600\Omega$, unless otherwise noted)

		SGM8631/2/3/4							
PARAMETER	CONDITION	TYP		MIN/M	AX OVER	AX OVER TEMPERATURE			
		+25℃	+25℃	0℃ to 70℃	-40 ℃ to 85 ℃	-40℃ to 125℃	UNITS	MIN/ MAX	
INPUT CHARACTERISTICS									
Input Offset Voltage (Vos)		0.8	3.5	3.9	4.3	4.6	mV	MAX	
Input Bias Current (I _B)		1					pА	TYP	
Input Offset Current (I _{OS})		1					pА	TYP	
Common-Mode Voltage Range (V _{CM})	V _S = 5.5V	-0.1 to +5.6					V	TYP	
Common-Mode Rejection Ratio(CMRR)	$V_S = 5.5V, V_{CM} = -0.1V \text{ to 4 V}$	90	75	74	74	73	dB	MIN	
	$V_S = 5.5V$, $V_{CM} = -0.1V$ to 5.6 V	83					dB	MIN	
Open-Loop Voltage Gain(A _{OL})	$R_L = 600\Omega$, $Vo = 0.15V$ to 4.85V	97	90	87	86	79	dB	MIN	
	$R_L = 10K\Omega$, $Vo = 0.05V$ to 4.95V	108					dB	MIN	
Input Offset Voltage Drift ($\Delta V_{OS}/\Delta_T$)		2.4					μV/°C	TYP	
OUTPUT CHARACTERISTICS									
Output Voltage Swing from Rail	$R_1 = 600\Omega$	0.1					V	TYP	
catput rollage chang non-tan	$R_L = 10K\Omega$	0.015					V		
Output Current (I _{OUT})	10102	53	49	45	40	35	mA	MIN	
Closed-Loop Output Impedance	F = 200KHz, G = 1	3	.0		10		Ω	TYP	
POWER-DOWN DISABLE	. 2001.11.12, 0								
Turn-On Time		4					μs	TYP	
Turn-Off Time		1.2					μs	TYP	
DISABLE Voltage-Off		1.2	0.8				μs V	MAX	
DISABLE Voltage-On			2				V	MIN	
							· ·	IVIIIV	
POWER SUPPLY			0.5	0.5	0.5	0.5			
Operating Voltage Range			2.5	2.5	2.5	2.5	V	MIN	
D 0 1 D : " D " (DODD)	N 10514 15514		5.5	5.5	5.5	5.5	V	MAX	
Power Supply Rejection Ratio (PSRR)	$V_s = +2.5 \text{ V to } +5.5 \text{ V}$		00		70				
0: 10 (// // // // // // // // // // // // //	$V_{CM} = (-V_S) + 0.5V$	91	80	78	78	77	dB	MIN	
Quiescent Current/ Amplifier (I _Q)	I _{OUT} = 0	470	590	660	680	740	μA	MAX	
Supply Current when Disabled		00							
(SGM8633 only)		90					nA	MAX	
DYNAMIC PERFORMANCE									
Gain-Bandwidth Product (GBP)	$R_L = 10K\Omega$	6					MHz	TYP	
Phase Margin(φ _O)		60		1			degrees	TYP	
Full Power Bandwidth(BW _P)	$<$ 1% distortion, R _L = 600 Ω	250		1			KHz	TYP	
Slew Rate (SR)	$G = +1$, 2V Step, $R_L = 10K\Omega$	3.7		1			V/µs	TYP	
Settling Time to 0.1%(t _S)	$G = +1, 2 V Step, R_L = 600Ω$	2.1		1			μs	TYP	
Overload Recovery Time	V_{IN} ·Gain = Vs, R_L = 600 Ω	0.9		ļ			μs	TYP	
NOISE PERFORMANCE				1					
Voltage Noise Density (en)	f = 1kHz	12		1			$\text{nV}/_{\sqrt{Hz}}$	TYP	
Current Noise Density(in)	f = 1kHz	3					$fA / \sqrt{\mathit{Hz}}$	TYP	

Specifications subject to change without notice.

PACKAGE/ORDERING INFORMATION

MODEL	ORDER NUMBER	PACKAGE DESCRIPTION	PACKAGE OPTION	MARKING INFORMATION
SGM8631	SGM8631XC5/TR	SC70-5	Tape and Reel, 3000	8631
	SGM8631XN5/TR	SOT23-5	Tape and Reel, 3000	8631
	SGM8631XS/TR	SO-8	Tape and Reel, 2500	SGM8631XS
SGM8632	SGM8632XMS/TR	MSOP-8	Tape and Reel, 3000	SGM8632XMS
	SGM8632XS/TR	SO-8	Tape and Reel, 2500	SGM8632XS
SGM8633	SGM8633XN6/TR	SOT23-6	Tape and Reel, 3000	8633
	SGM8633XS/TR	SO-8	Tape and Reel, 2500	SGM8633XS
SGM8634	SGM8634XS/TR	SO-16	Tape and Reel, 2500	SGM8634XS
	SGM8634XTS	TSSOP-16	Tape and Reel, 3000	SGM8634XTS

ABSOLUTE MAXIMUM RATINGS

Supply Voltage, V+ to V
Common-Mode Input Voltage
$(-Vs) - 0.5 V \text{ to } (+Vs) + 0.5V$
Storage Temperature Range–65 $^{\circ}\mathrm{C}$ to +150 $^{\circ}\mathrm{C}$
Junction Temperature160℃
Operating Temperature Range–55 $^{\circ}$ C to +150 $^{\circ}$ C
Package Thermal Resistance @ T _A = 25 °C
SC70-5, θ_{JA}
SOT23-5, θ_{JA}
SOT23-6, θ_{JA}
SO-8, θ_{JA}
MSOP-8, θ_{JA}
SO-16, θ _{JA}
TSSOP-16, θ _{JA}
Lead Temperature Range (Soldering 10 sec)
260℃
ESD Susceptibility
HBM1500V
MM400V

NOTES

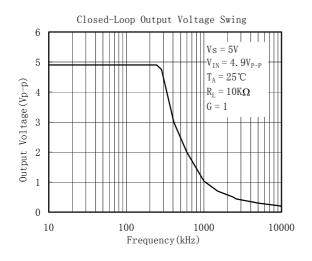
1. Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

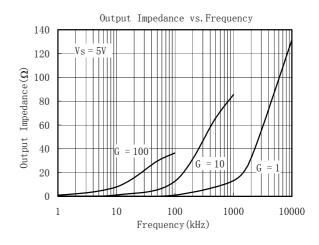
CAUTION

This integrated circuit can be damaged by ESD. Shengbang Micro-electronics recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

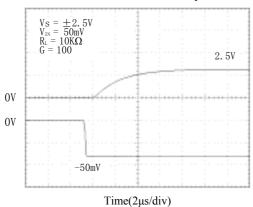
ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

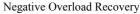
At $T_A = +25$ °C, $V_{CM} = V_S/2$, $R_L = 600\Omega$, unless otherwise noted.

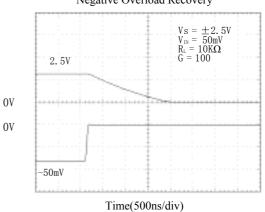




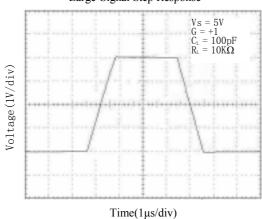
Positive Overload Recovery



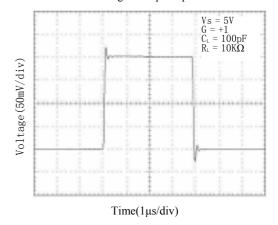


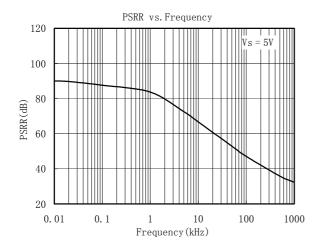


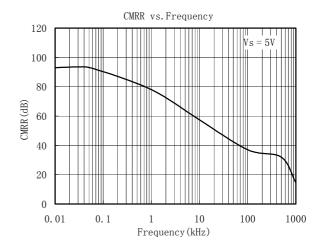
Large-Signal Step Response

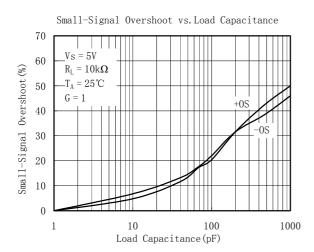


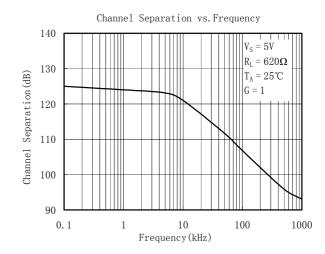
Small-Signal Step Response

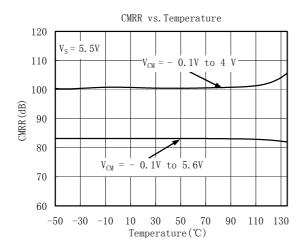


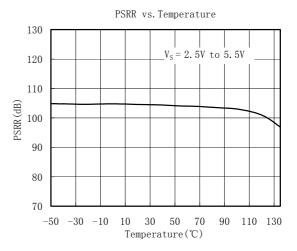


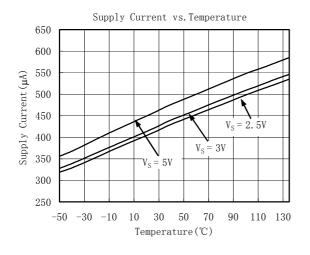


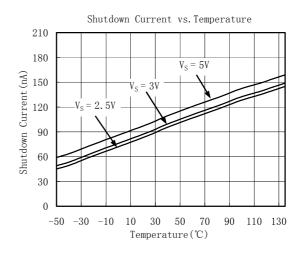


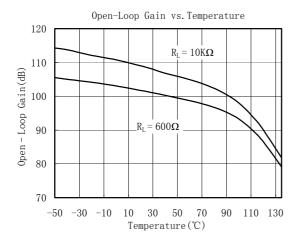


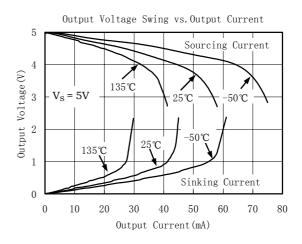


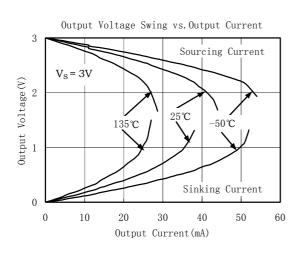


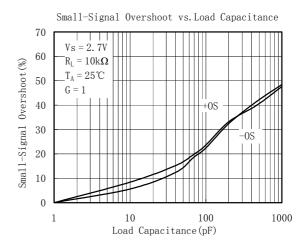


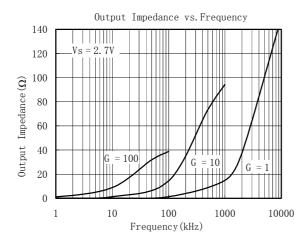


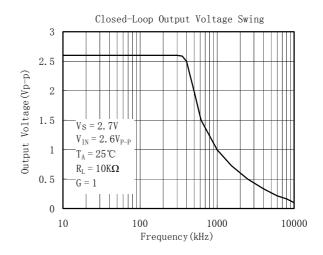


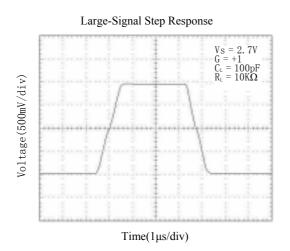


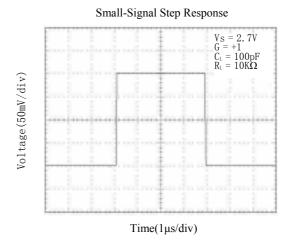


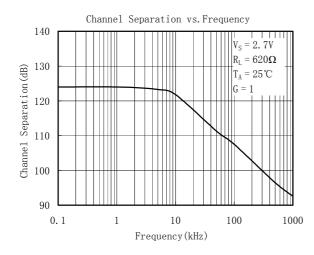


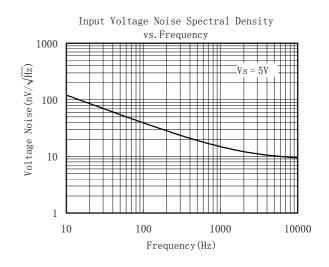


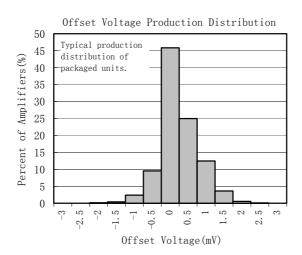












APPLICATION NOTES

Driving Capacitive Loads

The SGM863x can directly drive 1000pF in unity-gain without oscillation. The unity-gain follower (buffer) is the most sensitive configuration to capacitive loading. Direct capacitive loading reduces the phase margin of amplifiers and this results in ringing or even oscillation. Applications that require greater capacitive drive capability should use an isolation resistor between the output and the capacitive load like the circuit in Figure 1. The isolation resistor $R_{\rm ISO}$ and the load capacitor $C_{\rm L}$ form a zero to increase stability. The bigger the $R_{\rm ISO}$ resistor value, the more stable $V_{\rm OUT}$ will be. Note that this method results in a loss of gain accuracy because $R_{\rm ISO}$ forms a voltage divider with the $R_{\rm LOAD}$.

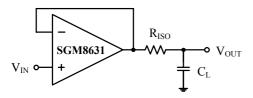


Figure 1. Indirectly Driving Heavy Capacitive Load

An improvement circuit is shown in Figure 2. It provides DC accuracy as well as AC stability. R_{F} provides the DC accuracy by connecting the inverting signal with the output. C_{F} and R_{Iso} serve to counteract the loss of phase margin by feeding the high frequency component of the output signal back to the amplifier's inverting input, thereby preserving phase margin in the overall feedback loop.

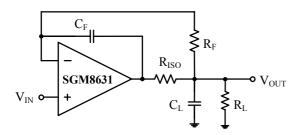


Figure 2. Indirectly Driving Heavy Capacitive Load with DC Accuracy

For no-buffer configuration, there are two others ways to increase the phase margin: (a) by increasing the amplifier's gain or (b) by placing a capacitor in parallel with the feedback resistor to counteract the parasitic capacitance associated with inverting node.

Power-Supply Bypassing and Layout

The SGM863x family operates from either a single +2.5V to +5.5V supply or dual $\pm 1.25V$ to $\pm 2.75V$ supplies. For single-supply operation, bypass the power supply V_{DD} with a $0.1\mu F$ ceramic capacitor which should be placed close to the V_{DD} pin. For dual-supply operation, both the V_{DD} and the V_{SS} supplies should be bypassed to ground with separate $0.1\mu F$ ceramic capacitors. $2.2\mu F$ tantalum capacitor can be added for better performance.

Good PC board layout techniques optimize performance by decreasing the amount of stray capacitance at the op amp's inputs and output. To decrease stray capacitance, minimize trace lengths and widths by placing external components as close to the device as possible. Use surface-mount components whenever possible.

For the operational amplifier, soldering the part to the board directly is strongly recommended. Try to keep the high frequency big current loop area small to minimize the EMI (electromagnetic interfacing).

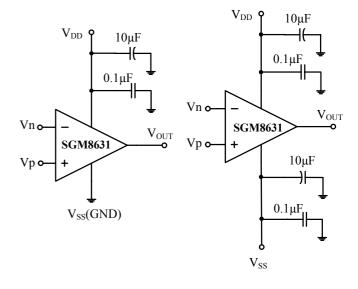


Figure 3. Amplifier with Bypass Capacitors

Grounding

A ground plane layer is important for SGM863x circuit design. The length of the current path speed currents in an inductive ground return will create an unwanted voltage noise. Broad ground plane areas will reduce the parasitic inductance.

Input-to-Output Coupling

To minimize capacitive coupling, the input and output signal traces should not be parallel. This helps reduce unwanted positive feedback.

Typical Application Circuits

Differential Amplifier

The circuit shown in Figure 4 performs the difference function. If the resistors ratios are equal (R4 / R3 = R2 / R1), then V_{OUT} = (V_{D} – V_{D}) × V_{D} + V_{D} (V_{D} – V_{D}) × V_{D} + $V_$

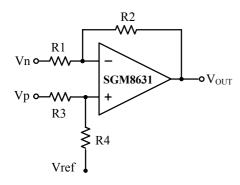


Figure 4. Differential Amplifier

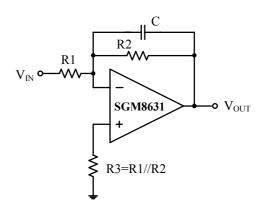


Figure 6. Low Pass Active Filter

Instrumentation Amplifier

The circuit in Figure 5 performs the same function as that in Figure 4 but with the high input impedance.

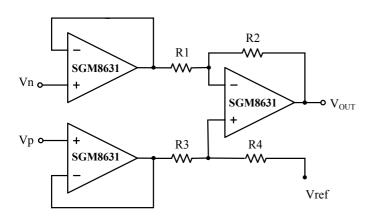
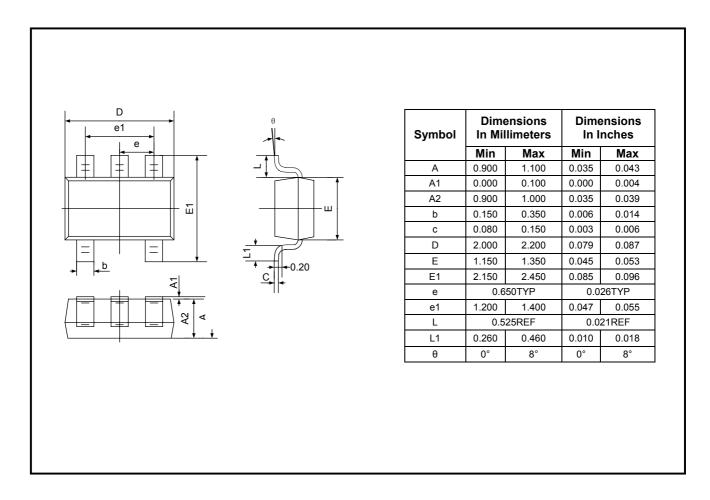


Figure 5. Instrumentation Amplifier

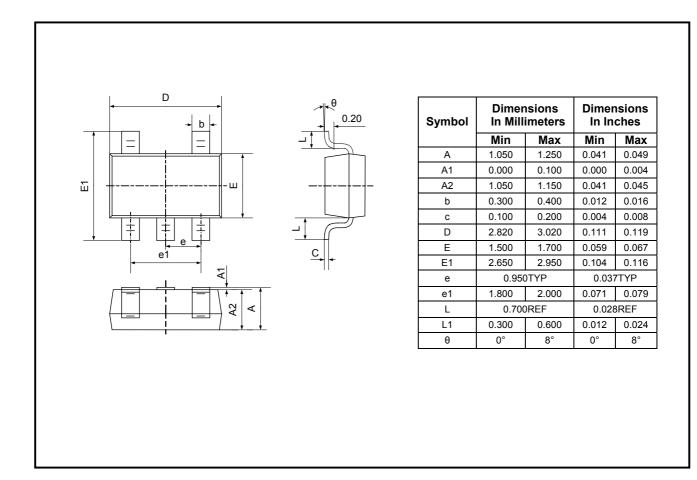
Low Pass Active Filter

The low pass filter shown in Figure 6 has a DC gain of $(-R_2/R_1)$ and the -3dB corner frequency is $1/2\pi R_2 C$. Make sure the filter is within the bandwidth of the amplifier. The Large values of feedback resistors can couple with parasitic capacitance and cause undesired effects such as ringing or oscillation in high-speed amplifiers. Keep resistors value as low as possible and consistent with output loading consideration.

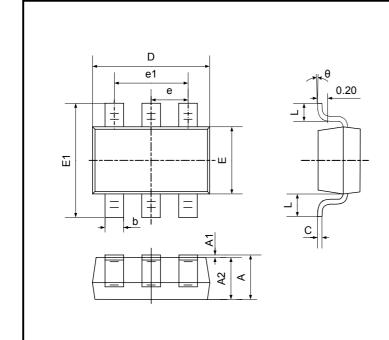
SC70-5



SOT23-5

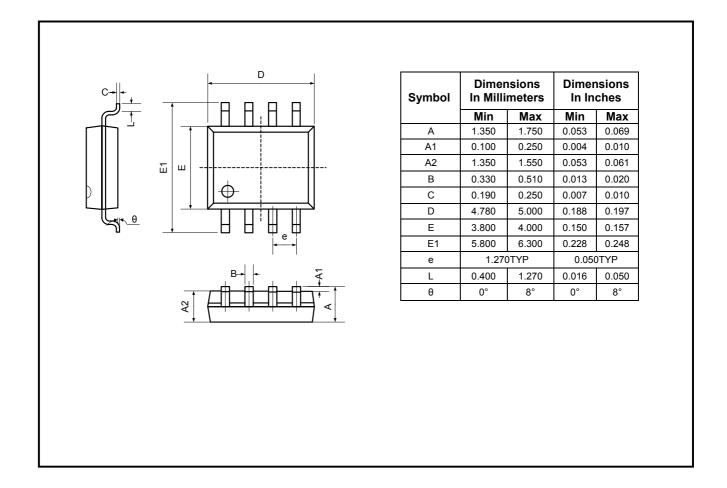


SOT23-6

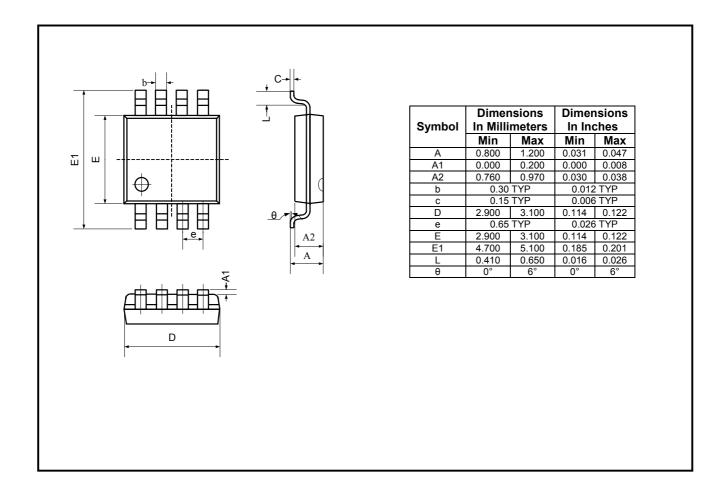


Symbol		nsions imeters	Dimensions In Inches		
	Min	Max	Min	Max	
Α	1.050	1.250	0.041	0.049	
A1	0.000	0.100	0.000	0.004	
A2	1.050	1.150	0.041	0.045	
b	0.300	0.400	0.012	0.016	
С	0.100	0.200	0.004	0.008	
D	2.820	3.020	0.111	0.119	
E	1.500	1.700	0.059	0.067	
E1	2.650	2.950	0.104	0.116	
е	0.950TYP		0.037TYP		
e1	1.800	2.000	0.071	0.079	
L	0.700REF		0.028REF		
L1	0.300	0.600	0.012	0.024	
θ	0°	8°	0°	8°	

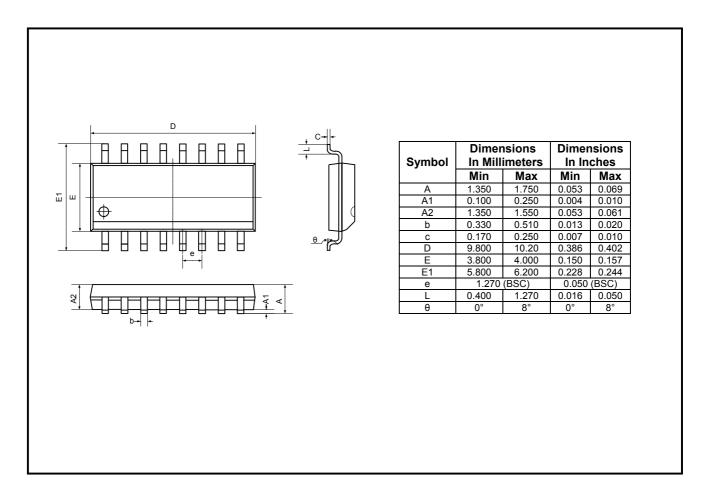
SO-8



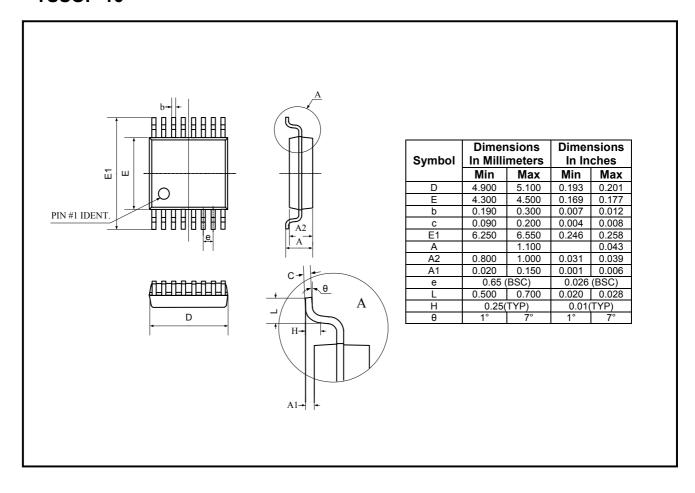
MSOP-8



SO-16



TSSOP-16



REVISION HISTORY

Location	Page
11/06— Data Sheet changed from REV.A to REV.B	
Added SC70-5 PACKAGE	Universal
Changes to PRODUCT DESCRIPTION, FEATURES, and PIN CONFIGURATIONS	
Updated PACKAGE/ORDERING INFORMATION	
Changes to ABSOLUTE MAXIMUM ATINGS	

$Shengbang\ Microelectronics\ Co,\ Ltd$

Unit 3, ChuangYe Plaza No.5, TaiHu Northern Street, YingBin Road Centralized Industrial Park Harbin Development Zone Harbin, HeiLongJiang 150078 P.R. China

Tel.: 86-451-84348461 Fax: 86-451-84308461 www.sg-micro.com